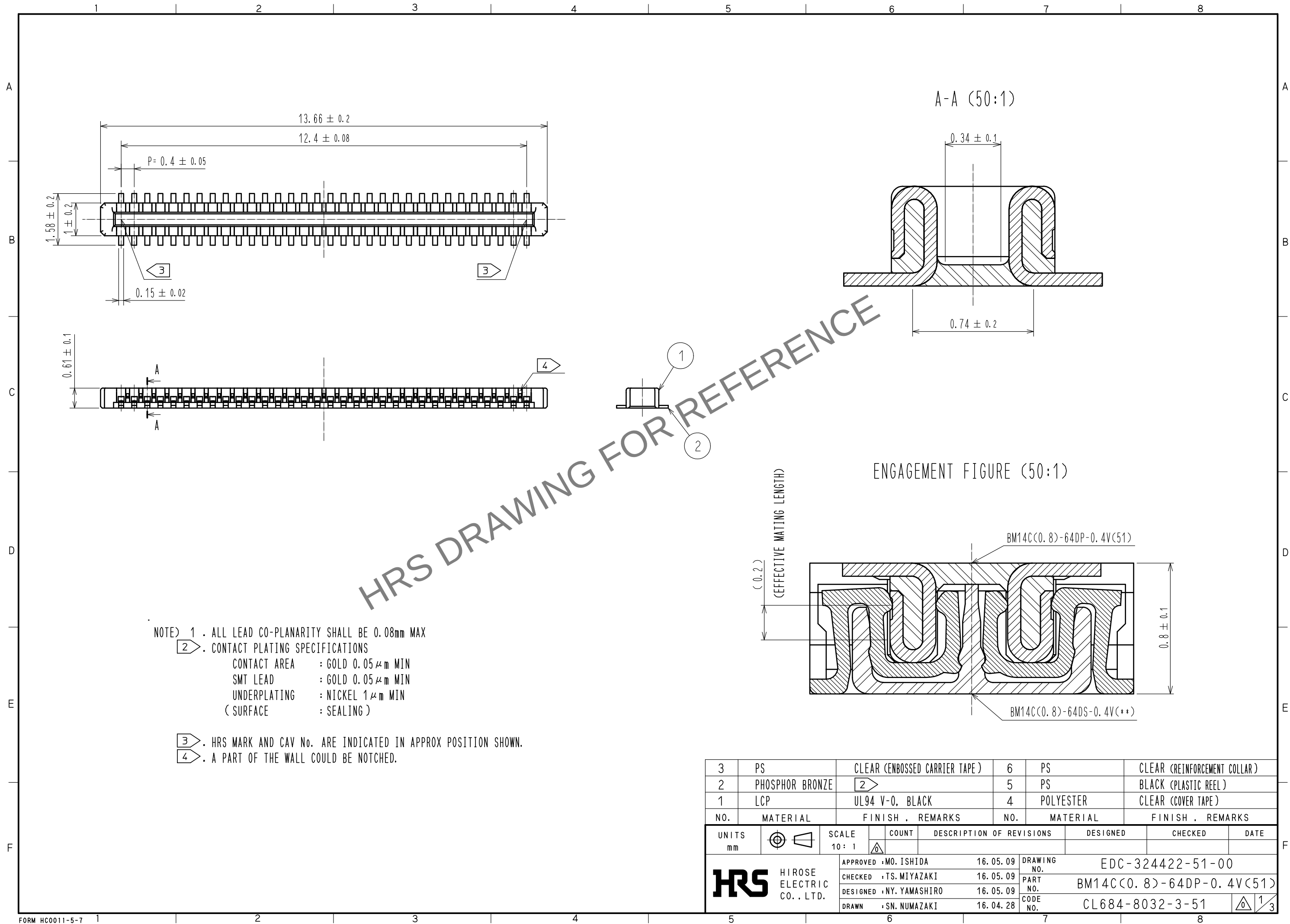
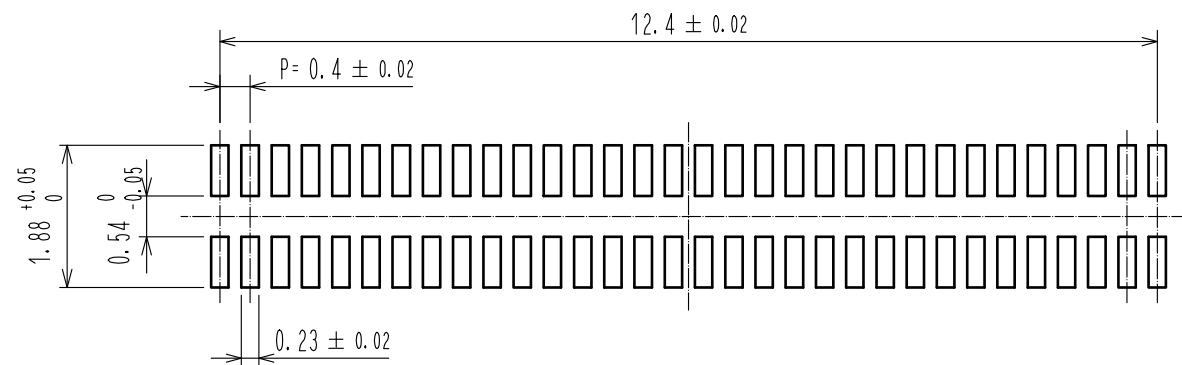


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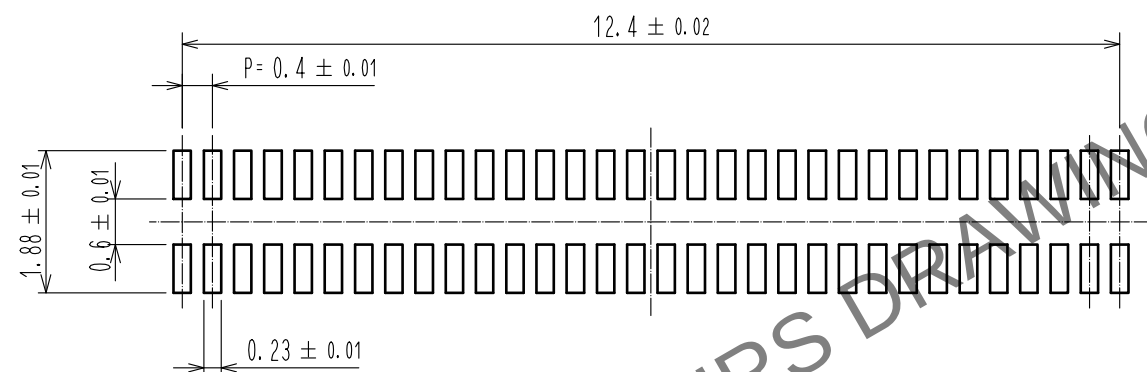
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◆ RECOMMENDED PCB LAYOUT

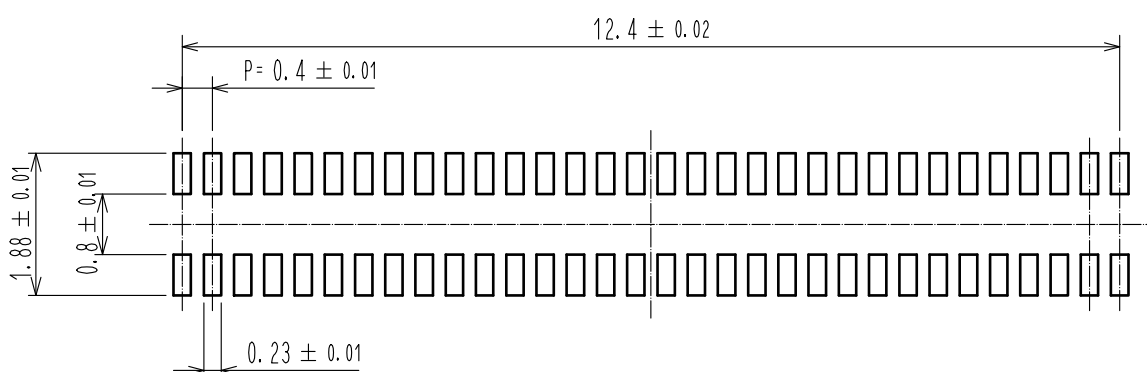


◆ RECOMMENDED METAL MASK DIMENSIONS

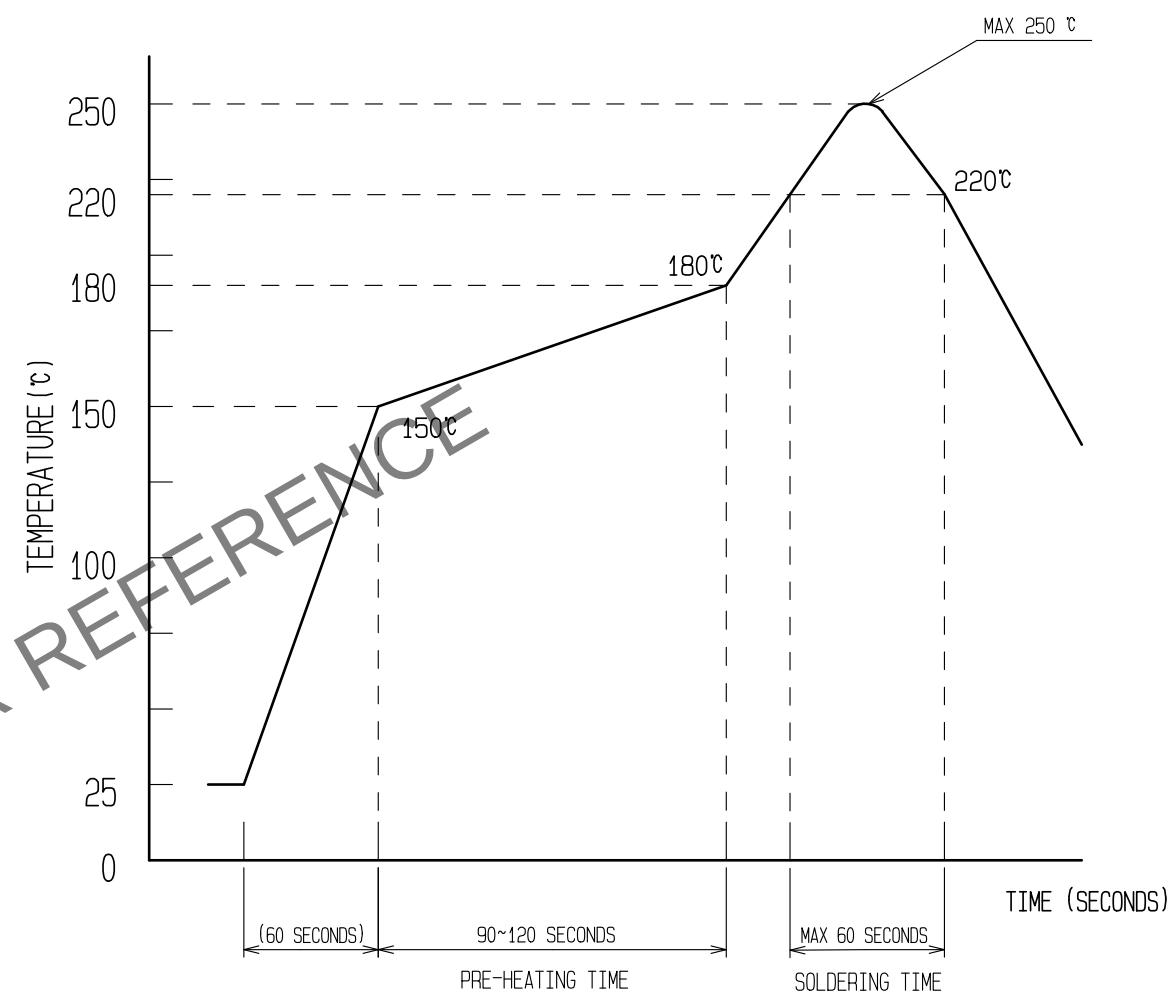
METAL MASK THICKNESS : $100 \mu\text{m}$



METAL MASK THICKNESS : $120 \mu\text{m}$



6 RECOMMENDED REFLOW TEMPERATURE PROFILE USING LEAD-FREE SOLDER PASTE.



REFLOW METHOD: IR REFLOW
NUMBER OF REFLOW CYCLES: 2 CYCLES MAX.

- 1) REFLOW TIME
DURATION ABOVE 220 $^{\circ}\text{C}$, 60 SEC. MAX.
(PEAK TEMPERATURE: 250 $^{\circ}\text{C}$ MAX)
- 2) PRE-HEAT TIME
PRE-HEAT TEMPERATURE(MIN): 150 $^{\circ}\text{C}$
PRE-HEAT TEMPERATURE(MAX): 180 $^{\circ}\text{C}$
PRE-HEAT TIME: 90-120 sec.

6 THIS TEMPERATURE PROFILE IS PER THE CONDITIONS SHOWN ABOVE. ADDITIONAL FACTORS, SUCH AS SOLDER PASTE TYPE, PCB SIZE AND OTHER MOUNTED COMPONENTS COULD AFFECT THE PROFILE, THEREFORE, A THOROUGH EVALUATION OF MOUNTING CONDITION IS REQUIRED PRIOR TO PRODUCTION. TEMPERATURE IS MEASURED AT CONTACT LEAD.

HRS

DRAWING NO.	EDC-324422-51-00
PART NO.	BM14C(0.8)-64DP-0.4V(51)
CODE NO.	CL684-8032-3-51

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